

N-Channel Enhancement MOSFET

Features

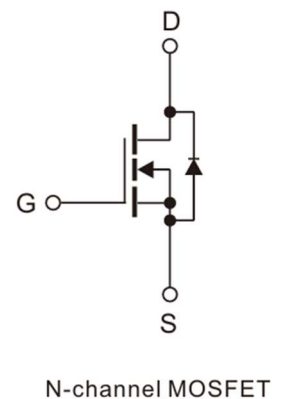
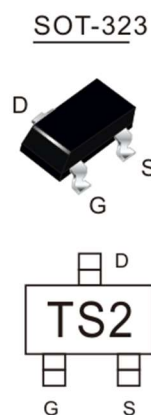
- Trench Power LV MOSFET technology
- Voltage Controlled Small Signal Switch
- Halogen-Free & Lead-Free

Product Summary		
V_{DS}	$R_{DS(on)}$ (m Ω) Typ	I_D (A)
20V	57@ 4.5V, 2.5A	3
	72@ 2.5V, 2.0A	

Application

- Load Switch for Portable Devices
- DC/DC Converter

Marking information



Absolute Maximum Ratings (at $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 10	V
Continuous drain current ($T_A = 25^\circ\text{C}$)	I_D	3.0	A
Continuous drain current ($T_A = 75^\circ\text{C}$)	I_D	2.4	A
Pulsed drain current ¹⁾	I_{DM}	14	A
Power Dissipation	P_D	0.25	W
Operating Junction	T_J	-55~150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55~150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	500	$^\circ\text{C/W}$

Characteristics at T_J = 25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at V _{GS} =0V, I _D =250μA	BV _{DSS}	20			V
Drain-Source Leakage Current at V _{DS} =20V, V _{GS} =0V	I _{DSS}			1	μA
Gate Leakage Current at V _{GS} =±10V, V _{DS} =0V	I _{GSS}			±0.1	μA
Gate-Source Threshold Voltage at V _{DS} =V _{GS} , I _D =250μA	V _{GS(th)}	0.55		1.1	V
Drain-Source On-State Resistance at V _{GS} =4.5V, I _D =2.5A at V _{GS} =2.5V, I _D =2.0A	R _{DS(on)}		57 72	70 98	mΩ
DYNAMIC PARAMETERS					
Input Capacitance at V _{DS} =10V, V _{GS} =0V, f=1MHz	C _{iss}		220		pF
Output Capacitance at V _{DS} =10V, V _{GS} =0V, f=1MHz	C _{oss}		34		pF
Reverse Transfer Capacitance at V _{DS} =10V, V _{GS} =0V, f=1MHz	C _{rss}		26		pF
Gate charge total at V _{DS} =10V, V _{GS} =4.5V, I _D =2.5A	Q _g		3.61		nC
Gate to Source Charge at V _{DS} =10V, V _{GS} =4.5V, I _D =2.5A	Q _{gs}		0.88		nC
Gate to Drain Charge at V _{DS} =10V, V _{GS} =4.5V, I _D =2.5A	Q _{gd}		0.77		nC
Turn-On Delay Time at V _{DS} =10V, R _L =1.5Ω, R _{GEN} =3Ω, V _{GS} =4.5V	t _{d(on)}		6.8		nS
Turn-On Rise Time at V _{DS} =10V, R _L =1.5Ω, R _{GEN} =3Ω, V _{GS} =4.5V	t _r		57		ns
Turn-Off Delay Time at V _{DS} =10V, R _L =1.5Ω, R _{GEN} =3Ω, V _{GS} =4.5V	t _{d(off)}		14		nS
Turn-On Fall Time at V _{DS} =10V, R _L =1.5Ω, R _{GEN} =3Ω, V _{GS} =4.5V	t _f		53		ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at I _S =0.3A, V _{GS} =0V	V _{SD}			1.2	V
Maximum Body-Diode Continuous Current	I _S			3	A

Notes : 1. Repetitive Rating: Pulse width limited by maximum junction temperature
Pulse Test: Pulse width ≤300μS, Duty cycle≤2%

Electrical Characteristics Curves

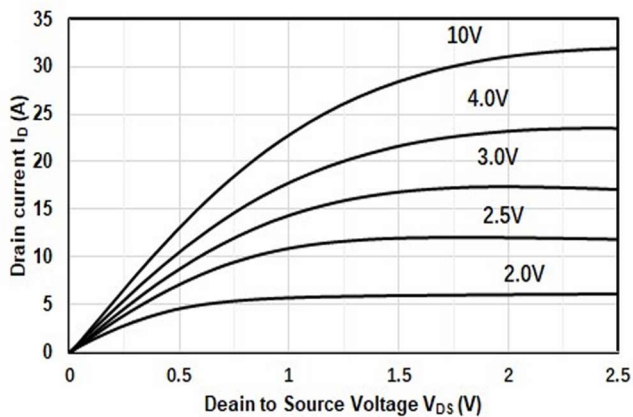


Figure1. Output Characteristics

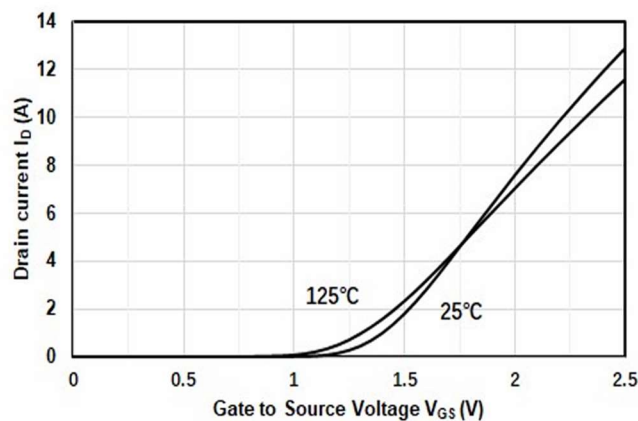


Figure2. Transfer Characteristics

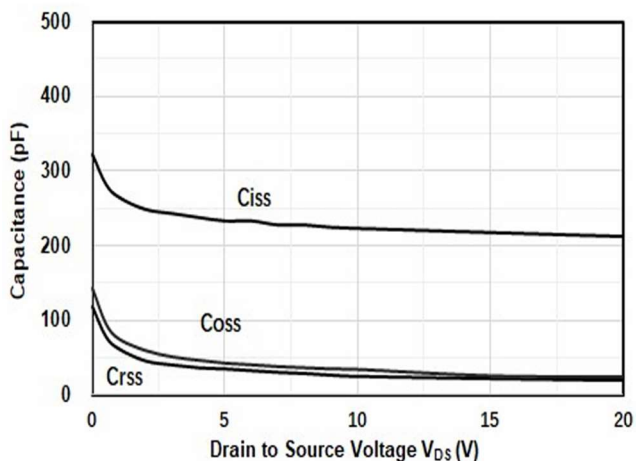


Figure3. Capacitance Characteristics

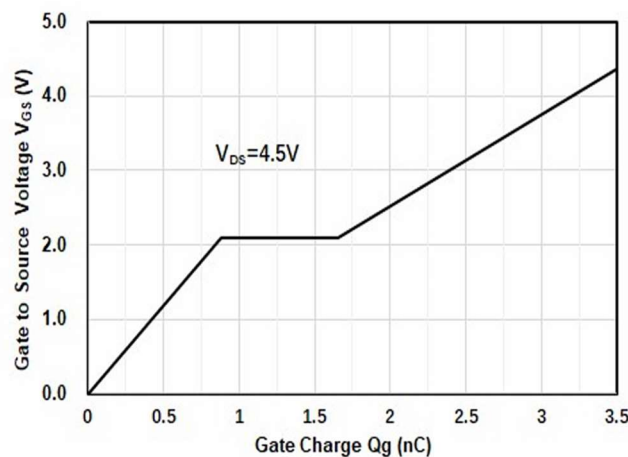


Figure4. Gate Charge

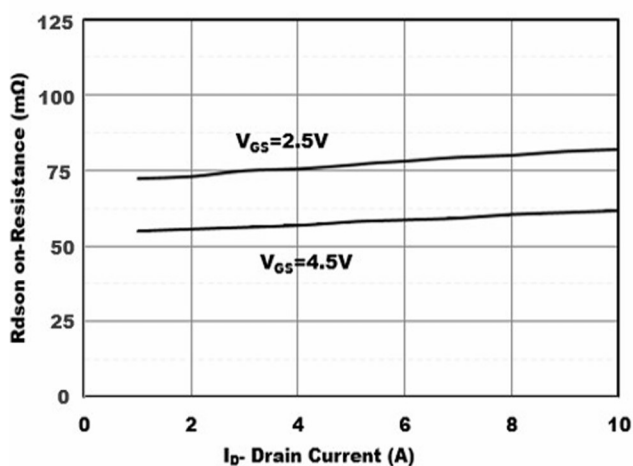


Figure5. Drain-Source on Resistance

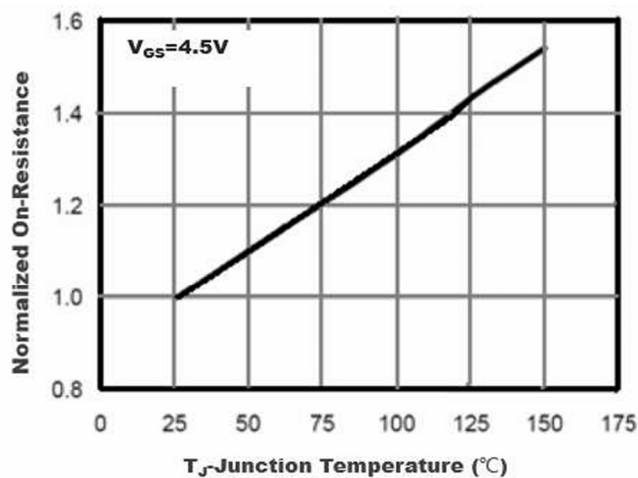


Figure6. Drain-Source on Resistance

Electrical Characteristics Curves

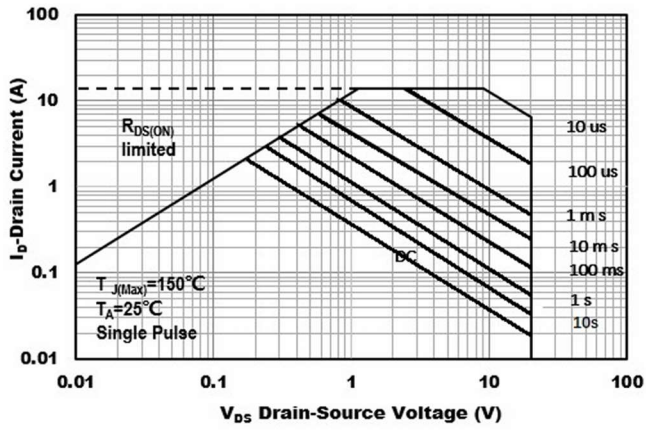


Figure7. Safe Operation Area

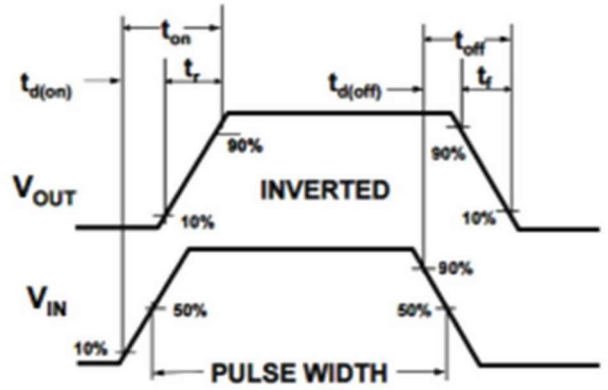
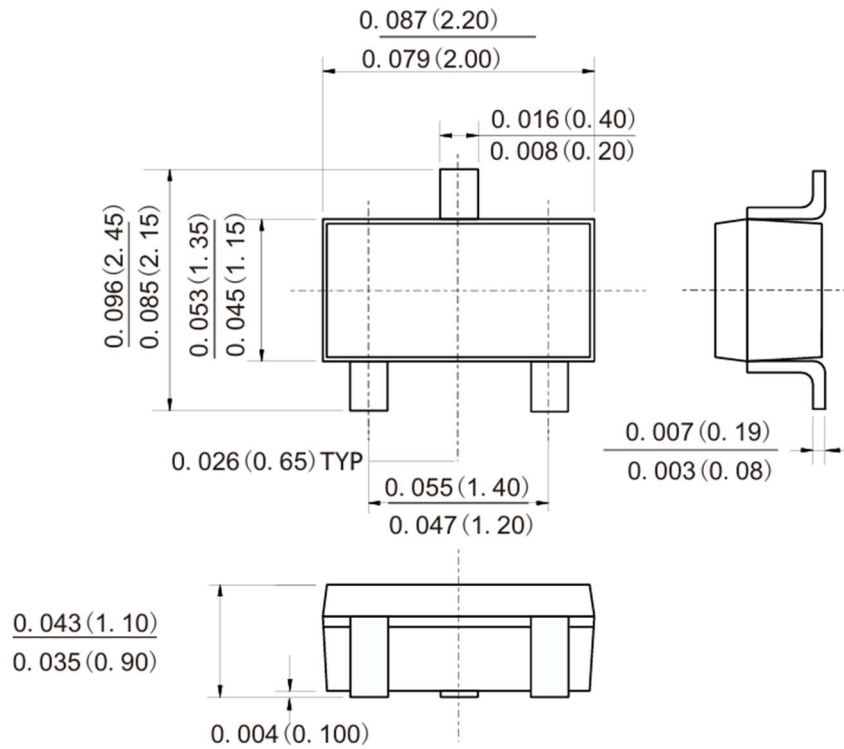


Figure8. Switching wave

Order Information

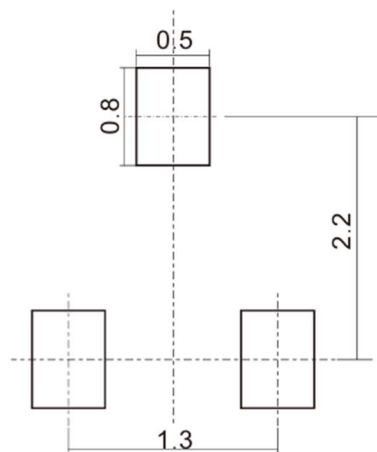
Part Number	Package	Quantity
Sh2102W	SOT-323	3000

Package Outline Dimensions (Units: mm) SOT-323



Dimensions in inches and (millimeters)

Suggested Pad Layout



Dimensions in millimeters